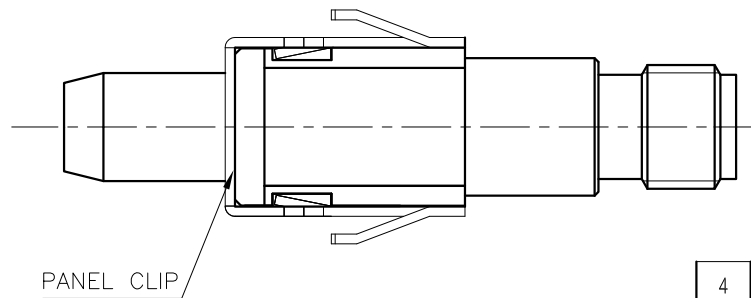
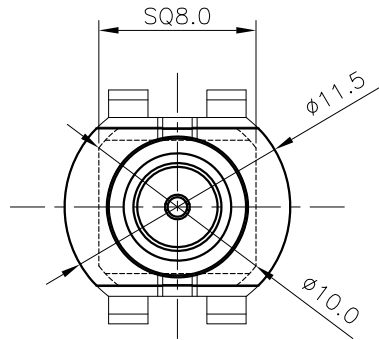
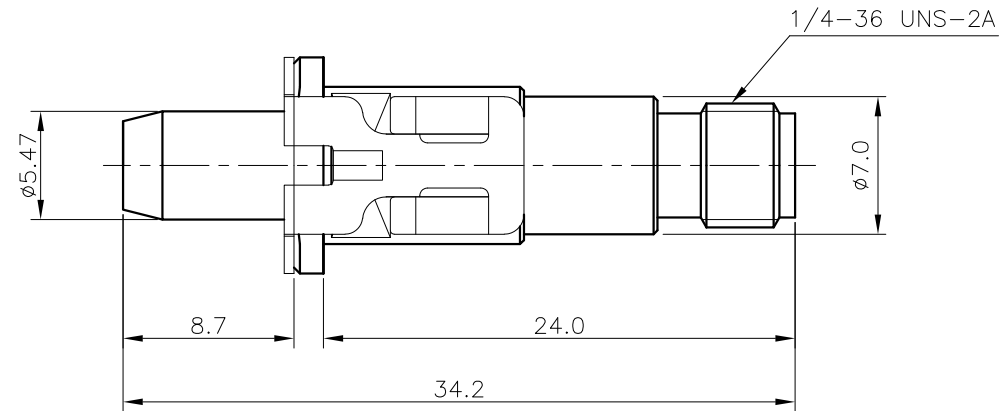
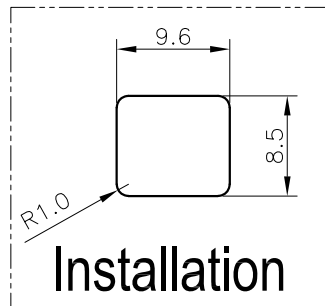


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1P	Initial Registration	H.J.LEE	I.C.KIM	2015.01.13.



4	LOCK PANEL	1	Stainless steel (0.4~0.5t)		DSR01125-N/1
3	INSULATOR	2	TEFLON		DIN00190-N/1
2	CONTACT	1	BeCu	Gold Plate	DAC00282-5/1
1	BODY	1	MBsBD	Nickel Plate	DAD00286-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE



Installation

* PCB 두께 권장 사양 : 3.2t ±0.1mm

TOLERANCE	Decimal ±0.1	DATE 2015. 01. 13.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM				
MATERIAL _____		CHECKED BY	TITLE SMA50 (J) PDM50 (J) 4H ADAPTOR			
		DRAWN BY H.J.LEE				
FINISH _____		SCALE 2.5/1	UNIT mm		A4	DWG NO. AD00552-7/1
						REVISION I R